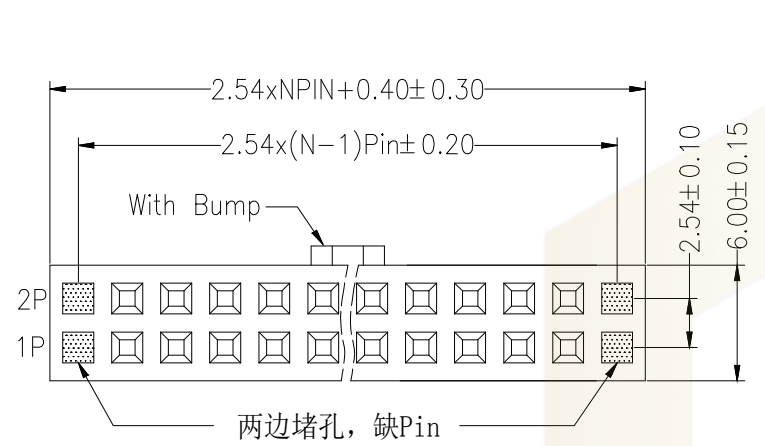
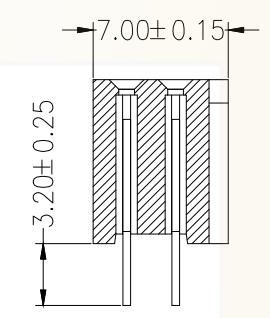
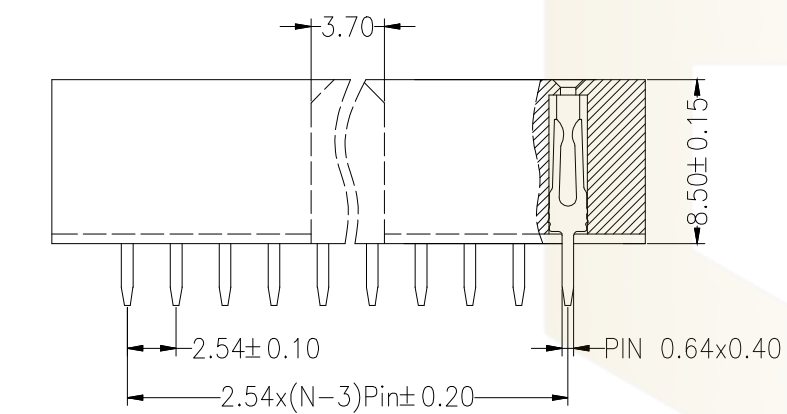


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

Contact Material:Copper Alloy

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 260°C±5°C 5S

Ordering Information

PM 254 - * - N - Z - * - BPQ* - **

No.of Rows	No.of Pins	Type	Length (Plastic)	Option Type	(脚Pin序号)	Contact Plating
1=Single Row	02-40Pin	2=直针 4=带针 5=空针 6=带针	(塑高)	BP=With Bump		G0:Gold Flash G1:1u" Gold G2:3u" Gold G3:5u" Gold G4:10u" Gold G5:15u" Gold G6:30u" Gold S0:Gold Flash/Tin S1:Tin

GENERAL TOLERANCE			制图	深圳市华灿天禄电子有限公司			
DIM TOL			审核	ShenzhenhuacantianluELECTRONICS CO., LTD			
X.X ±0.30			批准	产品名称	2.54双排 排母 直针 带凸台	版本	A
X.XX ±0.20			比例	TITLE	缺针 (塑高8.5)	REV.	
X.XXX ±0.10			SCALE	产品料号	PM254-2-N-Z-8.5-BPQX-XX (L11.7)	单位	mm
Angle ±3.0°			投影	PART NO.		页次	1/1
序号	变更内容	日期	材料	MATERIAL		SHEET	
No.	MODIFY CONTENT	MODIFY DATE					